

Multilayer Ceramic Chip Capacitors

CGA9N2X7R2A335K230KA



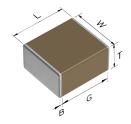






TDK item description CGA9N2X7R2A335KT****

Applications	Automotive Grade	
Feature	Mid Wid Voltage (100 to 630V) AEC-Q200 AEC-Q200	
Series	CGA9(5750) [EIA 2220]	
Status	Production	



	Size
Length(L)	5.70mm ±0.40mm
Width(W)	5.00mm ±0.40mm
Thickness(T)	2.30mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	4.10mm to 4.80mm
Recommended Land Pattern (PB)	1.20mm to 1.40mm
Recommended Land Pattern (PC)	4.00mm to 5.00mm

Electrical Characteristics		
Capacitance	$3.3 \mu F \pm 10\%$	
Rated Voltage	100VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	151ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	500pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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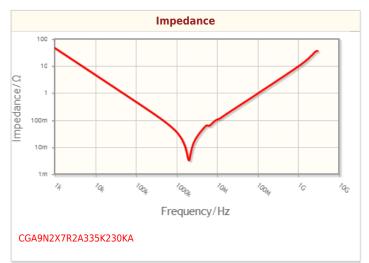


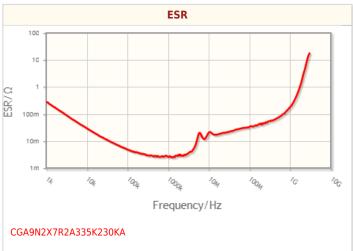


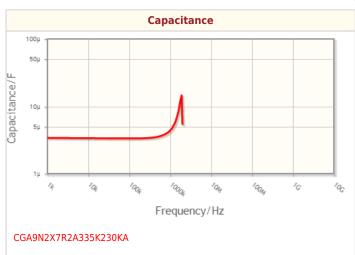




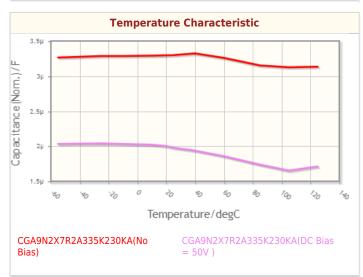
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

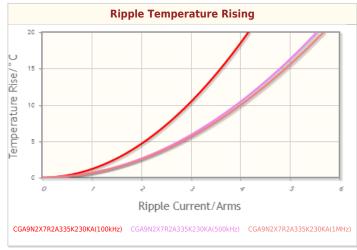












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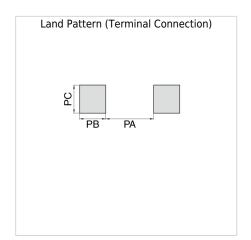








Associated Images



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